

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1-8. (Canceled).

Claim 9 (Original): A ceramic circuit board comprising:

a ceramic substrate having a through hole;

a metal column arranged within the through hole; and

metal circuit plates attached to both surfaces of the ceramic substrate in such a way as to stop up the through hole,

wherein the metal circuit plates attached to both surfaces of the ceramic substrate are connected to each other by the metal column,

and wherein, between an inner wall surface of the through hole and an outer wall surface of the metal column is secured a space which is 30 to 200 μm long.

Claim 10 (Original): The ceramic circuit board of claim 9,
wherein the metal circuit plate is made of copper or aluminum.

Claim 11 (Original): The ceramic circuit board of claim 9,
wherein the metal column is made of copper or aluminum.

Claims 12-15 (Canceled).